

**Nominal frequency (f0)**

**12.8 MHz**

### Frequency stabilities

Parameter	Frequency stability	Operating temp. range
Over all (df/f0) vs. operating temp. range (df/f@25 °C)	-4.6 to 4.6 ppm -0.28 to 0.28 ppm	-40 ... 85 °C
Additional information Temperature slope max: ±0.2ppm/°C		
Parameter	Value	Condition
initial tolerance (df/f0)	-1 to 1 ppm	@ 25 °C
vs. supply voltage change (df/f)	-0.2 to 0.2 ppm	static; 3.3 V ±5 %
vs. load change (df/f)	-0.2 to 0.2 ppm	static; Load ± 10 %
vs. aging / 20 years (df/f)	± 2.5 ppm	@ 40 °C
Holdover 24 h	± 0.32 ppm	incl. temp. stab. -40...+85°C
overall incl.: initial, temp.-40...+85°C, supply, load var. and aging 20 years		

### RF output

Parameter	Value	Condition
Signal	LVC MOS	
Load	15 pF ±10 %	
Fan out	3	
Rise Time	< 5 ns	@ 10 to 90 %Vout
Fall Time	< 5 ns	@ 90 to 10 %Vout
Duty cycle	40 / 60 %	@ 1.65 V
V Low	x < 0.3 V	
V High	x > 3 V	
Enable function	Enable Function Pin 8	output Pin 5
	high	data
	open	data
	low	high tristate

### Supply voltage

Parameter	Value	Condition
Supply voltage (Vs)	3.3 V ± 5 %	
Current consumption steady state	< 6 mA	@ Vsnom & 25 °C

### Additional Parameters

Parameter	Typ.	Max.	Condition
Phase Noise	-97		dBc/Hz@10Hz
	-118		dBc/Hz@100Hz
	-140		dBc/Hz@1000Hz
	-152		dBc/Hz@10kHz
	-153		dBc/Hz@100kHz
	-153		dBc/Hz@1000kHz
Parameter	Value		Condition
Start-up time	< 10 ms		
Additional information This SMD oscillator is designed only for pick and place/reflow soldering process. Manual soldering may damage the part and therefore not recommended for the mounting of this oscillator.			
Processing & Packing	handling&processing note		

### Additional environmental conditions

Sealing test A nicht dicht (not hermetically sealed)
Solderability J_STD_002B Cond A leaded/ Cond. B SMD 245°C (diving time 5±0.5s) Dip+Look with 8h damp treatment: solder wetting >95%

**Absolute Maximum Ratings**

Parameter	Min	Typ	Max	Units	Condition
Operable temperature range	-40		85	°C	
Storage temperature range	-55		125	°C	

**Enclosure**

Type G290	Height 1.8 mm
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**G 290**

Padvorschlag  
land pattern  
recommendation

all units in mm

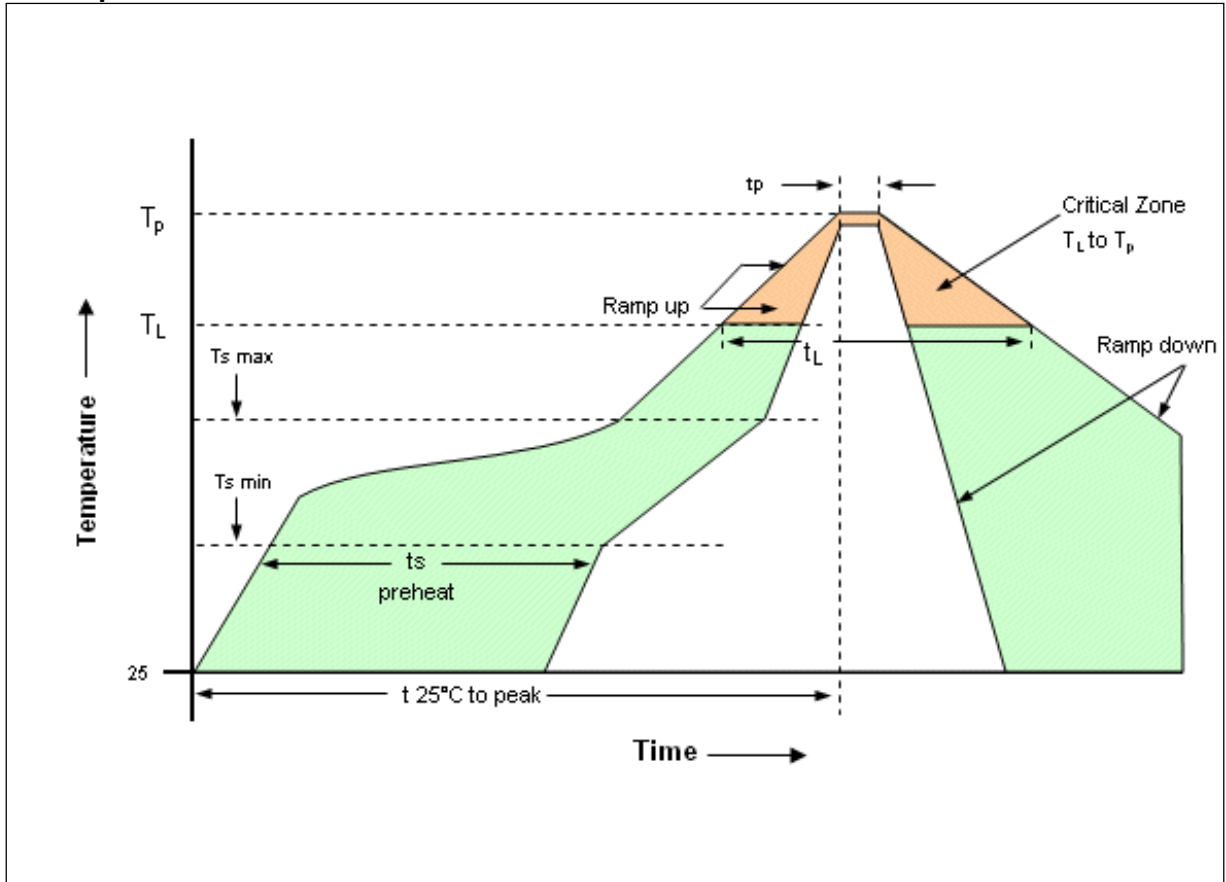
**Pin Connections**

Pin 1: I.C.	2: N.C.
Pin 3: I.C.	4: GND
Pin 5: RF-Output	6: N.C.
Pin 7: N.C.	8: Enable
Pin 9: V_supply	10: N.C.

**Marking**

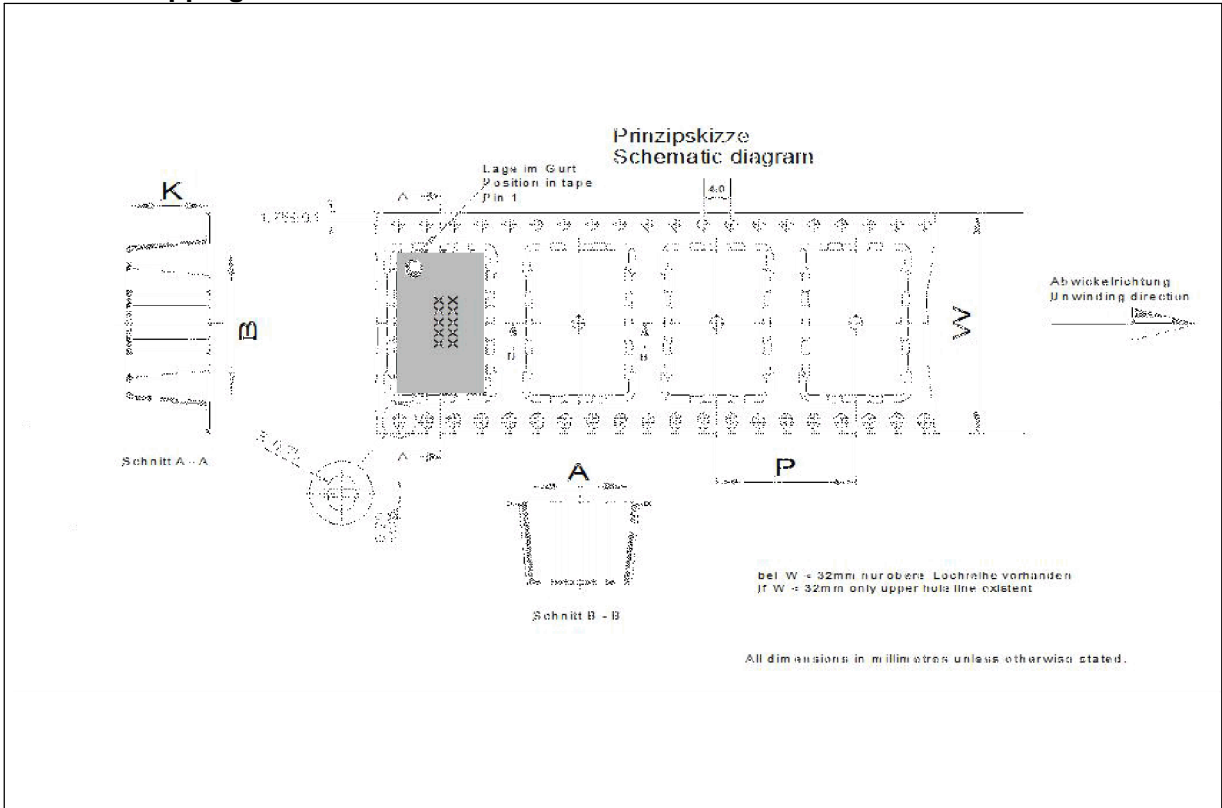
TX-007  
12M800  
\*VAYYWW  
-  
-  
\* pin-1 marking

**Reflow profile**



Profile Feature	Pb-Free Assembly/Sn-Pb Assembly
Average ramp-up rate (TL to Tp)	3°C/second max.
Preheat -Temperature Min (T <sub>smin</sub> )	150°C
-Temperature Min (T <sub>smax</sub> )	200°C
-Time (min to max) (t <sub>s</sub> )	60-180 seconds
T <sub>smax</sub> to TL - Ramp-up Rate	3°C/second max.
Time maintainted above - Temperature (TL)	217°C
- Time (t <sub>L</sub> )	60-150 seconds
Peak Temperature (T <sub>p</sub> )	max 260°C
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.
Note: All temperatures refer to topside of the package, measured on the package body surface.	
Additional Information	
This SMD oscillator has been designed for pick and place reflow soldering.	

**Standard shipping method**



Tape width W [mm]	Quantity per meter	Quantity per reel	P [mm]	A [mm]	B [mm]	K [mm]
16	125	750	8	5.4	7.4	2.7

**Notes:**

Unless otherwise stated all values are valid after warm-up time and refer to typical conditions for supply voltage, frequency control voltage, load, temperature (25°C).  
Subject to technical modification.

**For Additional Information, Please Contact**

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